IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Hiroshi TAKANASHI et al.

Serial No. [NEW]

Filed December 20, 2000

NEGATIVE-WORKING PHOTOSENSITIVE : RESIN COMPOSITION AND PHOTOSEN-

SITIVE RESIN PLATE USING THE SAME (Rule 1.53(b) Continuation-in-Part

of Serial No. 09/262,077, Filed March 4, 1999):

#2

Attn: Application Branch

Attorney Docket No. 2000-1749

THE COMMISSIONER IS AUTHORIZED TO CHARGE ANY DEFICIENCY IN THE FEE FOR THIS PAPER TO DEPOSIT ACCOUNT NO. 23-0975.

INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner for Patents Washington, DC 20231

Sir:

Pursuant to the provisions of 37 CFR 1.56, 1.97 and 1.98, Applicants request consideration of [X] the references listed on attached form PTO-1449 and/or [] the additional information identified below in paragraph 3. A legible copy of each reference listed on the form PTO-1449 and each U.S. patent application listed below is enclosed, except a copy is not provided for each reference previously cited by or submitted to the Patent Office in prior parent application Serial No. 09/262,077.

1a. [X] This Information Disclosure Statement is submitted:

within three months of the filing date (or of entry into the National Stage) of the above-entitled application, or

before the mailing date of the first Office Action on the merits, or

before the mailing of a first Office Action after the filing of a request for continued examination,

and thus no certification and/or fee is required.

1b.	[] This Information Disclosure Statement is submitted
	after the events of above paragraph 1a and prior to the mailing date of a final Office Action or a Notice of Allowance or an action which otherwise closes prosecution in the application, and thus:
	(1) [] the certification of paragraph 2 below is provided, or
	(2) [] the fee of \$180.00 specified in 37 CFR 1.17(p) is enclosed.
1c.	[] This Information Disclosure Statement is submitted:
	after the mailing date of a final Office Action or Notice of Allowance or action which otherwise closes prosecution in the application, and prior to payment of the issue fee, and thus:
	the certification of paragraph 2 below is provided, and
	the fee of \$180.00 specified in 37 CFR 1.17(p) is enclosed.
2.	It is hereby certified
	a. [] that each item of information contained in this Information Disclosure Statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of the Statement, or
	b. [] that no item of information contained in the Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application and, to the knowledge of the person signing the certification after making reasonable inquiry, was known to any individual designated in §1.56(c) more than three months prior to the filing of the Statement.
3. []	Consideration of the following additional information (including any copending or abandoned U.S. application, prior uses and/or sales, etc.) is requested.

4. For each non-English language reference li made to:		rence listed on the attached form PTO-1449, reference is	
	a. [] a full or partial English langu	age translation submitted herewith,	
	b. [] a foreign patent office search	report (in the English language) submitted herewith,	
	c. [] the concise explanation conta	ained in the specification of the present application at	
	d. [X] the concise explanation set f parent application	orth in the English language abstracts submitted in the	
	e. [] the concise explanation set for reference:	orth below or on a separate sheet attached to the	
5.	. [X] Applicant also offers the following comments for the Examiner's consideration:		
	herewith. This reference was	91 and English language abstract therefor are submitted s not previously cited in the parent application. All of ecord in the parent application.	
6.	5. [] A foreign patent office search report citing one or more of the references is enclosed.		
		Respectfully submitted,	
		Hiroshi TAKANASHI et al.	
		Matthew Jacob Registration No. 25,154 Attorney for Applicants	
Teleph	n ngton, D.C. none (202) 721-8200 nber 20, 2000		